# **ACE2V3225**

## Automotive grade common-mode chip inductor



#### **Product features**

- AEC-Q200 qualified
- Compliant to OPEN Alliance 2.0
- 1210 (3225 metric) package
- Moisture sensitivity level (MSL): 1

#### **Applications**

- · Ethernet architectures
- Advanced driver assistance systems (ADAS)
- · Infotainment, safety cameras, sensors,
- Electric vehicle (xEV)
- · Powertrain

## **Environmental compliance and general specifications**

- Storage temperature rang (Component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant









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#### **Product specifications**

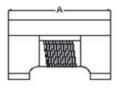
Part number	Common-mode impedance Z (Ω) at 10 MHz (1,4) - (2,3)	Common-mode inductance (µH) at 100 kHz, 0.1 Vrms (1-2), (3-4)	DCR¹ (Ω) @ +25 °C maximum	Irated² (mA) maximum	Rated voltage (Vdc) maximum	Insulation resistance (MΩ) minimum	Hipot³ (Vdc)
ACE2V3225-101-R	1500 minimum 3000 typical	80 -30%/+50%	3.12	100	50	10	125
ACE2V3225-201-R	6500 minimum 9500 typical	200 -10%/+30%	5.5	70	50	10	125

- 1. Direct current resistance (DCR) test parameters: (1-2), (3-4), 4-wire method, +25 °C
- 2. Irated: Maximum DC current for an approximate temperature rise of 40 °C: (1-2), (3-4)
- 3. Hi-pot test parameters: Winding Winding,  $\,5\,s$ , Leakage current <1 mA

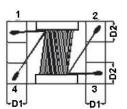
- 4. Part Number Definition: ACE2V3225-xxx-R
- ACE2V3225 = Product code and size
- xxx= inductance value in  $\mu H$ , last character equals number of zeros
- -R suffix = RoHS compliant

### Mechanical parameters, schematic, pad layout (mm)

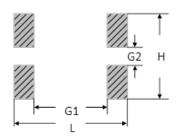
Drawing not to scale--(Pin numbers and dots are reference only-no polarity)



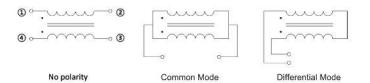




#### Recommended pad layout



## Schematic



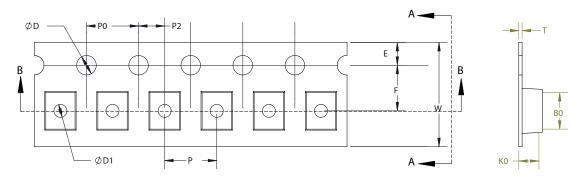
Part number	A	В	С	D1	D2	L	Н	G1	G2
ACE2V3225-xxx-R	3.3 ±0.2	2.5 ±0.2	2.5 max	0.55 ±0.15	1.0 ±0.2	3.7	2.8	2.4	0.6

Part marking: No marking
All soldering surfaces to be coplanar within 0.1 millimeters
Tolerances are ±0.5 millimeters unless stated otherwise
Pad layout dimensions are reference only
Traces or vias underneath the inductor is not recommended

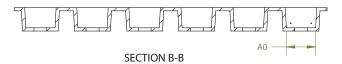
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### Packaging information (mm)

Supplied in tape and reel packaging, 2000 parts per 7" diameter reel (EIA-481 compliant) Drawing not to scale

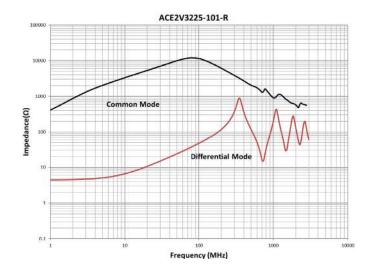


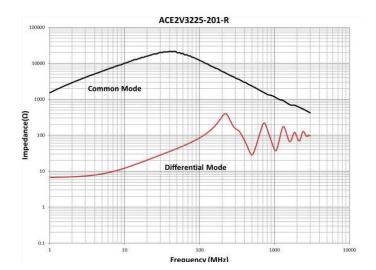
SECTION A-A



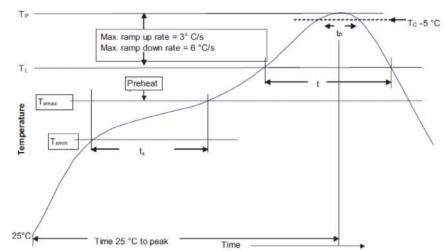
W±0.1	8.0
F±0.05	3.5
E±0.10	1.75
P0±0.10	4.0
P±0.10	4.0
P2±0.05	2.0
D+0.10/-0	1.5
D1±0.10	1.0
A0±0.10	2.88
B0±0.10	3.72
K0±0.10	2.5
T±0.05	0.26

#### **Performance curves**





#### Solder reflow profile



T<sub>C</sub> -5 °C Table 1 - Standard SnPb solder (T<sub>C</sub>)

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T<sub>C</sub>)

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

#### Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder	
Preheat and soak • Temperature min. (T <sub>smin</sub> )	100 °C	150 °C	
• Temperature max. (T <sub>smax</sub> )	150 °C	200 °C	
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds	
Ramp up rate T <sub>L</sub> to T <sub>p</sub>	3 °C/ second max.	3 °C/ second max.	
Liquidous temperature (TL) Time ( $t_L$ ) maintained above $T_L$	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time (t <sub>p</sub> )* within 5 °C of the specified classification temperature (T <sub>C</sub> )	20 seconds*	30 seconds*	
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 °C/ second max.	6 °C/ second max.	
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.	

 $<sup>^{\</sup>star}$  Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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